



Low-Dropout, 300mA Linear Regulators in SOT23

MAX8887/MAX8888

General Description

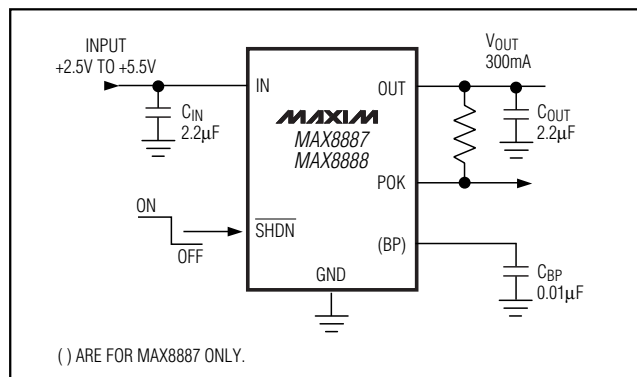
The MAX8887/MAX8888 low-dropout linear regulators operate from a +2.5V to +5.5V input and deliver up to 300mA continuous (500mA pulsed) current. The MAX8887 is optimized for low-noise operation, while the MAX8888 includes an open-drain POK output flag. Both regulators feature exceptionally low 100mV dropout at 200mA. These devices are available in a variety of preset output voltages in the +1.5V to +3.3V range.

An internal PMOS pass transistor allows the low 55µA supply current to remain independent of load, making these devices ideal for portable battery-powered equipment such as personal digital assistants (PDAs), cellular phones, cordless phones, and notebook computers. Other features include a micropower shutdown mode, short-circuit protection, thermal shutdown protection, and an active-low open-drain power-OK (POK) output that indicates when the output is out of regulation. The MAX8887/MAX8888 are available in a thin 5-pin SOT23 package that is only 1mm high.

Applications

Notebook Computers
Wireless Handsets
PDAs and Palmtop Computers
Digital Cameras
PCMCIA Cards
Hand-Held Instruments

Typical Operating Circuit



Features

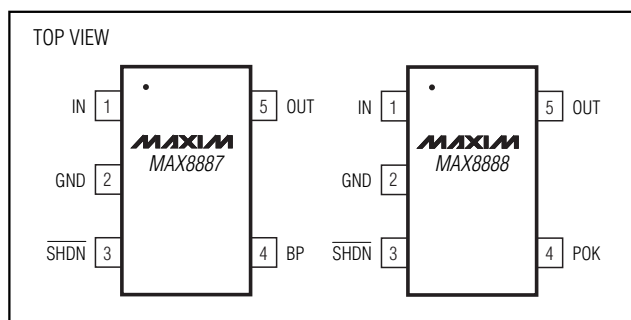
- ◆ Guaranteed 300mA Output Current (500mA for pulsed loads)
- ◆ Low 100mV Dropout at 200mA Load
- ◆ POK Output (MAX8888)
- ◆ 42µVRMS Output Noise (MAX8887)
- ◆ Preset Output Voltages (1.5V, 1.8V, 2.85V, and 3.3V)
- ◆ 55µA No-Load Supply Current
- ◆ Thermal-Overload and Short-Circuit Protection
- ◆ Foldback Output Current-Limit Protection
- ◆ 60dB PSRR at 1kHz
- ◆ 0.1µA Shutdown Current
- ◆ Thin 5-Pin SOT23 Package, 1mm High

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE	TOP MARK
MAX8887EZK15	-40°C to +85°C	5-SOT23	ADQD
MAX8887EZK18	-40°C to +85°C	5-SOT23	ADPX
MAX8887EZK29	-40°C to +85°C	5-SOT23	ADPY
MAX8887EZK33	-40°C to +85°C	5-SOT23	ADPZ
MAX8887EZKxy*	-40°C to +85°C	5-SOT23	—
MAX8888EZK15	-40°C to +85°C	5-SOT23	ADQE
MAX8888EZK18	-40°C to +85°C	5-SOT23	ADQA
MAX8888EZK29	-40°C to +85°C	5-SOT23	ADQB
MAX8888EZK33	-40°C to +85°C	5-SOT23	ADQC
MAX8888EZKxy*	-40°C to +85°C	5-SOT23	—

*Other versions (xy) between +1.5 and +3.3V are available in 100mV increments. Contact factory for other versions. Minimum order quantity is 25,000 units.

Pin Configurations



Maxim Integrated Products 1

For price, delivery, and to place orders, please contact Maxim Distribution at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

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ABSOLUTE MAXIMUM RATINGS

IN, $\overline{\text{SHDN}}$, POK, to GND.....-0.3V to +6.0V
 OUT, BP to GND-0.3 to ($V_{\text{IN}} + 0.3\text{V}$)
 Output Short-Circuit Duration.....Continuous
 Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)
 5-Pin SOT23 (derate 9.1mW/ $^\circ\text{C}$ above $+70^\circ\text{C}$).....727mW

Operating Temperature Ranges..... -40°C to $+85^\circ\text{C}$
 Junction Temperature $+150^\circ\text{C}$
 Storage Temperature Range -65°C to $+150^\circ\text{C}$
 Lead Temperature (soldering, 10s) $+500^\circ\text{C}$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

($V_{\text{IN}} = V_{\text{OUT}} + 1\text{V}$, $\overline{\text{SHDN}} = \text{IN}$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Voltage	V_{IN}			2.5		5.5	V
Input Undervoltage Lockout		V_{IN} rising (2% typical hysteresis)		2.15		2.4	V
Output Voltage Accuracy		$T_A = +25^\circ\text{C}$, $I_{\text{OUT}} = 100\text{mA}$		-1.2		+1.2	%
		$I_{\text{OUT}} = 100\mu\text{A}$ to 300mA , $T_A = 0^\circ\text{C}$ to $+85^\circ\text{C}$		-2		+2	
		$I_{\text{OUT}} = 100\mu\text{A}$ to 300mA		-3		+3	
Maximum Output Current		Continuous		300			mA
		10ms pulse			500		
Current Limit		$V_{\text{OUT}} = 0$		300			mA
		$V_{\text{OUT}} > 93\%$ of nominal value		420			
Ground-Pin Current		No load			55	100	μA
		$I_{\text{OUT}} = 300\text{mA}$			65		
Dropout Voltage (Note 2)		$V_{\text{OUT}} = +3.3\text{V}$	$I_{\text{OUT}} = 1\text{mA}$		0.5		mV
			$I_{\text{OUT}} = 200\text{mA}$		100	200	
			$I_{\text{OUT}} = 300\text{mA}$		150		
Line Regulation		$V_{\text{IN}} = 2.5\text{V}$ or ($V_{\text{OUT}} + 0.4\text{V}$) to 5.5V , $I_{\text{OUT}} = 5\text{mA}$		-0.15	0	0.15	%/V
Output Noise		MAX8887	10Hz to 100kHz, $C_{\text{BP}} = 0.01\mu\text{F}$, $C_{\text{OUT}} = 2.2\mu\text{F}$, $\text{ESR}_{\text{COUT}} < 0.1\Omega$		42		μVRMS
		MAX8888	10Hz to 100kHz, $C_{\text{OUT}} = 2.2\mu\text{F}$, $\text{ESR}_{\text{COUT}} < 0.1\Omega$		360		
PSRR		MAX8887	$f < 1\text{kHz}$, $C_{\text{BP}} = 0.01\mu\text{F}$, $C_{\text{OUT}} = 4.7\mu\text{F}$, $\text{ESR}_{\text{COUT}} < 0.1\Omega$		60		dB
		MAX8888	$f < 1\text{kHz}$, $C_{\text{OUT}} = 2.2\mu\text{F}$, $\text{ESR}_{\text{COUT}} < 0.1\Omega$		40		

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ELECTRICAL CHARACTERISTICS (continued)

($V_{IN} = V_{OUT} + 1V$, $\overline{SHDN} = IN$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted.) (Note 1)

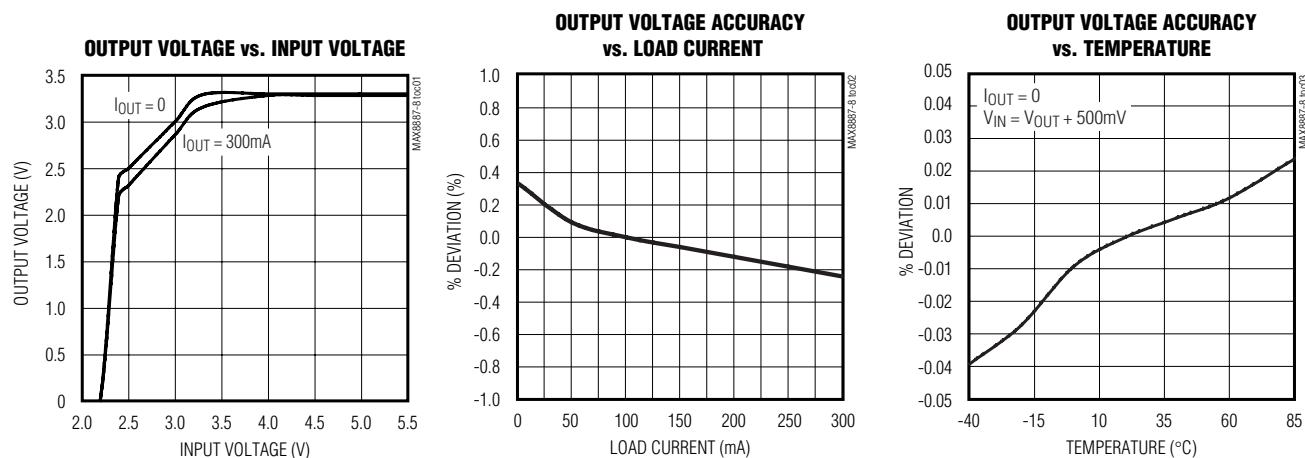
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SHUTDOWN						
Shutdown Supply Current		$\overline{SHDN} = GND$, $V_{IN} = 5.5V$		0.1	2	μA
$\overline{SHDN}$ Input Threshold	V_{IH}	$2.5V \leq V_{IN} \leq 5.5V$	1.6			V
	V_{IL}	$2.5V \leq V_{IN} \leq 5.5V$			0.6	
$\overline{SHDN}$ Input Bias Current		$\overline{SHDN} = IN$ or GND		10	100	nA
OUT Discharge Resistance in Shutdown		$\overline{SHDN} = GND$		650	1100	Ω
POK (MAX8888 ONLY)						
POK Trip Level, Referred to OUT Set Point		V_{OUT} falling (1% typical hysteresis)	90	92.5	95	%
Operating IN Voltage Range for Valid POK			1.0		5.5	V
POK Output Voltage Low	V_{OL}	$I_{SINK} = 1mA$			0.1	V
POK Output Leakage Current		$V_{POK} = 5.5V$, $\overline{SHDN} = IN$			100	nA
THERMAL PROTECTION						
Thermal Shutdown Temperature				170		$^{\circ}C$
Thermal Shutdown Hysteresis				20		$^{\circ}C$

Note 1: All parts are 100% tested at $T_A = +25^{\circ}C$. Limits over the operating temperature range are guaranteed by design.

Note 2: Typical and maximum dropout voltage for different output voltages are shown in *Typical Operating Characteristics* curve.

Typical Operating Characteristics

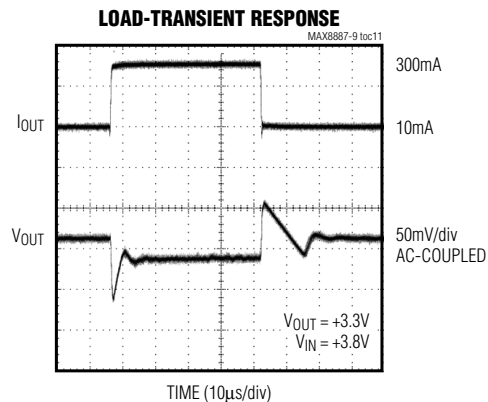
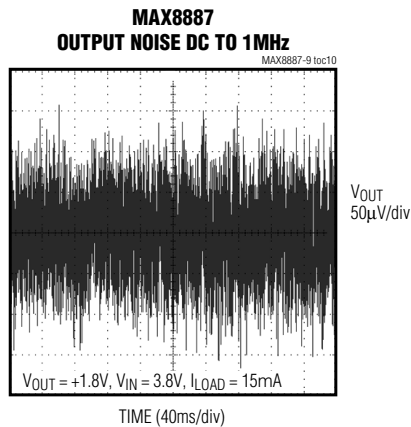
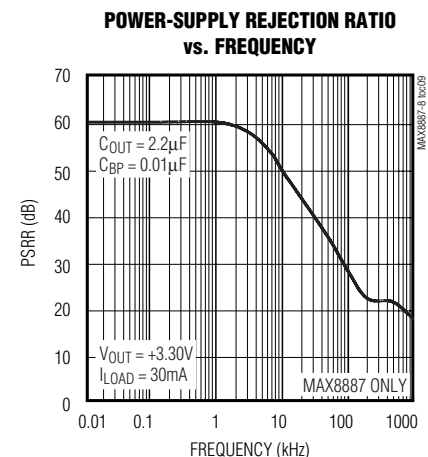
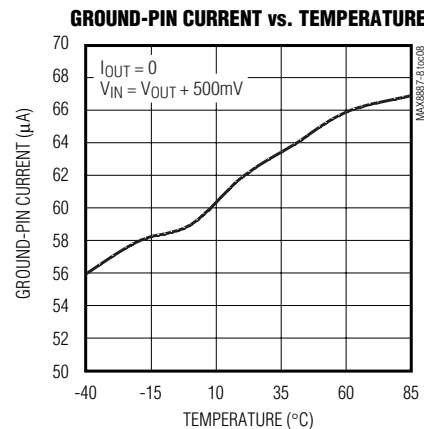
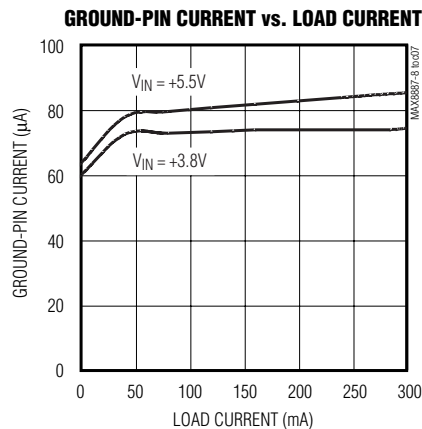
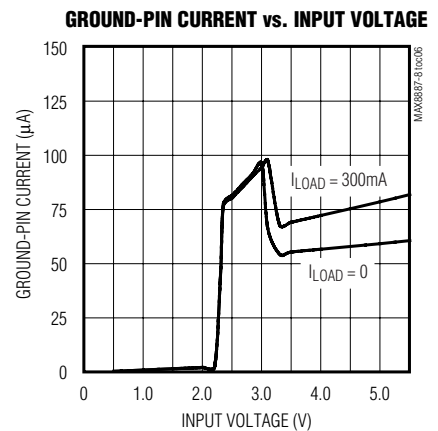
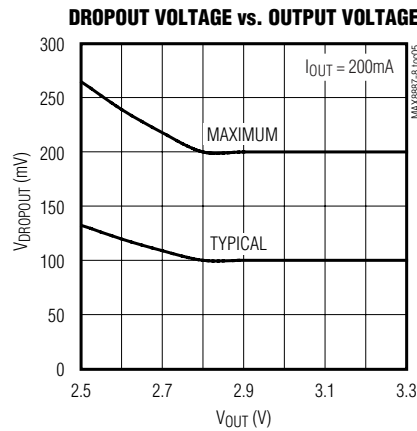
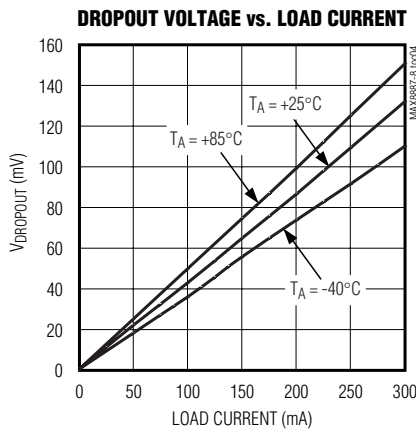
(Typical Operating Circuit, $T_A = +25^{\circ}C$, unless otherwise noted.)



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Typical Operating Characteristics (continued)

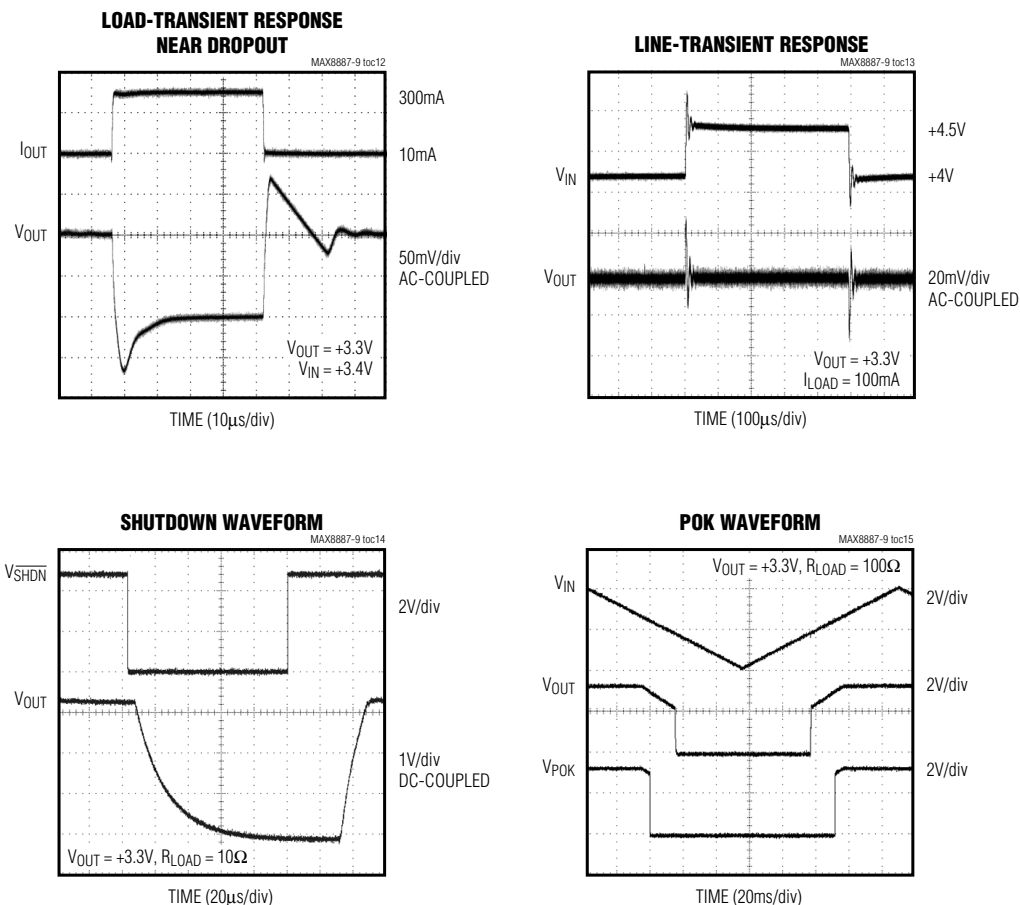
(Typical Operating Circuit, $T_A = +25^\circ\text{C}$, unless otherwise noted.)



Low-Dropout, 300mA Linear Regulators in SOT23

Typical Operating Characteristics (continued)

(Typical Operating Circuit, $T_A = +25^\circ\text{C}$, unless otherwise noted.)



Pin Description

MAX8887	MAX8888	NAME	FUNCTION
1	1	IN	Regulator Input. Supply voltage can range from 2.5V to 5.5V. Bypass with 2.2μF capacitor to GND (see <i>Capacitor Selection and Regulator Stability</i>).
2	2	GND	Ground
3	3	$\overline{\text{SHDN}}$	Active-Low Shutdown Input. A logic low reduces the supply current to below 0.1μA. In shutdown, POK and OUT are driven low. Connect to IN for normal operation.
—	4	POK	Open-Drain Active-Low POK Output. POK remains low while the output voltage (V_{OUT}) is below the reset threshold. Connect a 100kΩ pullup resistor to OUT to obtain a logic level output. POK is driven low in shutdown. If not used, leave this pin unconnected.
4	—	BP	Reference Bypass. Bypass with a low-leakage 0.01μF ceramic capacitor.
5	5	OUT	Regulator Output. Sources up to 300mA guaranteed. Bypass with 2.2μF (<0.2Ω typical ESR) ceramic capacitor to GND.

Low-Dropout, 300mA Linear Regulators in SOT23

Detailed Description

The MAX8887/MAX8888 are low-dropout, low-quiescent-current linear regulators designed primarily for battery-powered applications. The devices supply loads up to 300mA and are available in several fixed output voltages in the +1.5 to +3.3V range. The MAX8887 is optimized for low-noise operation, while the MAX8888 includes an open-drain POK output flag. As illustrated in Figure 1, the MAX8888 consists of a 1.25V reference, error amplifier, P-channel pass transistor, and internal feedback voltage divider.

Internal P-Channel Pass Transistor

The MAX8887/MAX8888 feature a 0.5Ω P-channel MOSFET pass transistor. Unlike similar designs using PNP pass transistors, P-channel MOSFETs require no base drive, which reduces quiescent current. PNP-based regulators also waste considerable current in dropout when the pass transistor saturates and use high base drive currents under large loads. The MAX8887/MAX8888 do not suffer from these problems and consume only 55 μ A of quiescent current under heavy loads as well as in dropout.

Output Voltage Selection

The MAX8887/MAX8888 are supplied with various factory-set output voltages ranging from 1.5V to 3.3V. The part number's two-digit suffix identifies the nominal output voltage. For example, the MAX8887EUK33 has a preset output voltage of 3.3V (see *Ordering Information*).

Shutdown

Drive $\overline{\text{SHDN}}$ low to enter shutdown. During shutdown, the output is disconnected from the input and supply current drops to 0.1 μ A. When in shutdown, POK and OUT are driven low. $\overline{\text{SHDN}}$ can be pulled as high as 6V, regardless of the input and output voltages.

Power-OK Output

The power-OK output (POK) pulls low when OUT is less than 93% of the nominal regulation voltage. Once OUT exceeds 93% of the nominal voltage, POK goes high impedance. POK is an open-drain N-channel output. To obtain a logic level output, connect a pullup resistor from POK to OUT. A 100k Ω resistor works well for most applications. POK can be used as a power-on-reset (POR) signal to a microcontroller (μ C) or to drive other logic. Adding a capacitor from POK to ground creates POK delay. When the MAX8887 is shut down, POK is held low independent of the output voltage. If unused, leave POK grounded or unconnected.

Current Limit

The MAX8887/MAX8888 monitor and control the pass transistor's gate voltage, limiting the output current to

0.8A (typ). This current limit is reduced to 500mA (typ) when the output voltage is below 93% of the nominal value to provide foldback current limiting.

Thermal-Overload Protection

Thermal-overload protection limits total power dissipation in the MAX8887/MAX8888. When the junction temperature exceeds $T_J = +170^\circ\text{C}$, a thermal sensor turns off the pass transistor, allowing the device to cool. The thermal sensor turns the pass transistor on again after the junction temperature cools by 20°C , resulting in a pulsed output during continuous thermal overload conditions. Thermal overload protection protects the MAX8887/MAX8888 in the event of fault conditions. For continuous operation, do not exceed the absolute maximum junction-temperature rating of $T_J = +150^\circ\text{C}$.

Operating Region and Power Dissipation

The MAX8887/MAX8888's maximum power dissipation depends on the thermal resistance of the IC package and circuit board. The temperature difference between the die junction and ambient air, and the rate of air flow. The power dissipated in the device is $P = I_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})$. The maximum allowed power dissipation is 727mW or:

$$P_{\text{MAX}} = (T_J(\text{MAX}) - T_A) / (\theta_{\text{JC}} + \theta_{\text{CA}})$$

where $T_J(\text{MAX}) - T_A$ is the temperature difference between the MAX8887/MAX8888 die junction and the surrounding air; θ_{JC} is the thermal resistance from the junction to the case; and θ_{CA} is the thermal resistance from the case through PC board, copper traces, and other materials to the surrounding air.

Refer to Figure 2 for the MAX8887/MAX8888 valid operating region.

Noise Reduction

For the MAX8887 only, an external 0.01 μ F bypass capacitor at BP creates a lowpass filter for noise reduction. The MAX8887 exhibits 42 μ V_{RMS} of output voltage noise with $C_{\text{BP}} = 0.01\mu\text{F}$ and $C_{\text{OUT}} = 2.2\mu\text{F}$ (see *Typical Operating Characteristics*).

Applications Information

Capacitor Selection and Regulator Stability

Connect a 2.2 μ F ceramic capacitor between IN and ground and a 2.2 μ F ceramic capacitor between OUT and ground. The input capacitor (C_{IN}) lowers the source impedance of the input supply. Reduce noise and improve load-transient response, stability, and power-supply rejection by using a larger ceramic output capacitor such as 4.7 μ F.

The output capacitor's (C_{OUT}) equivalent series resistance (ESR) affects stability and output noise. Use out-

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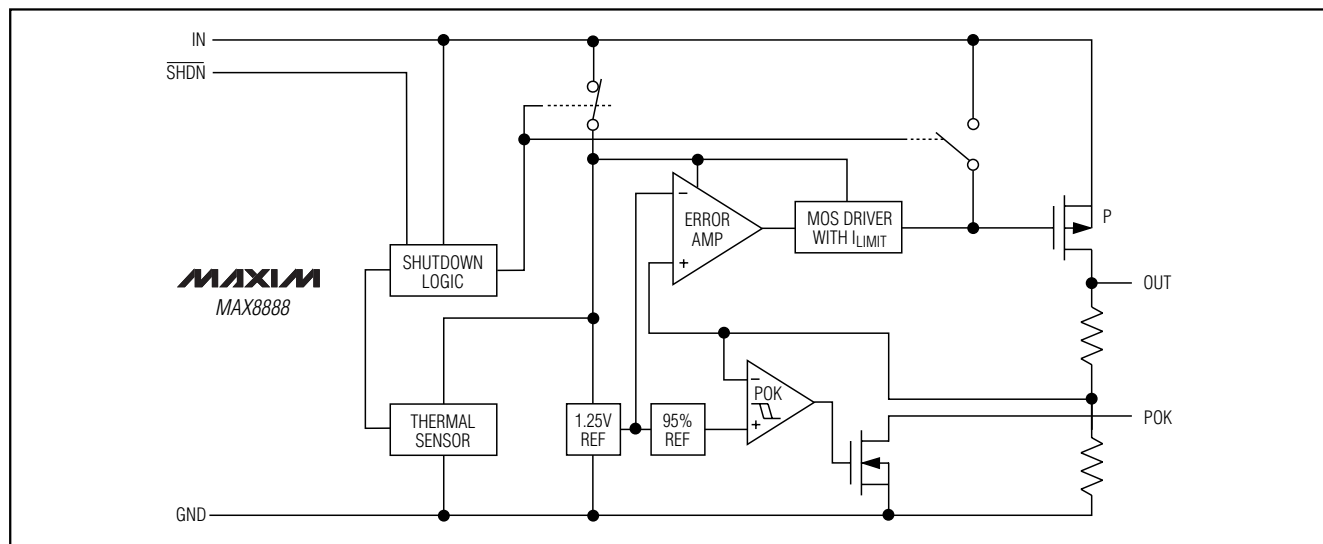


Figure 1. Functional Diagram

put capacitors with an ESR of 0.1Ω or less to ensure stability and optimum transient response. Surface-mount ceramic capacitors have very low ESR and are commonly available in values up to 10μF. Connect C_{IN} and C_{OUT} as close to the MAX8887/MAX8888 as possible to minimize the impact of PC board trace inductance.

Noise, PSRR, and Transient Response

The MAX8887/MAX8888 are designed to operate with low dropout voltages and low quiescent currents in battery-powered systems while still maintaining excellent noise, transient response, and AC rejection. See the *Typical Operating Characteristics* for a plot of power-supply rejection ratio (PSRR) versus frequency. When operating from noisy sources, improved supply-noise rejection and transient response can be achieved by increasing the values of the input and output bypass capacitors and through passive filtering techniques.

Input-Output (Dropout) Voltage

A regulator's minimum input-to-output voltage differential (dropout voltage) determines the lowest usable supply voltage at which the output is regulated. In battery-powered systems, this determines the useful end-of-life battery voltage. The MAX8887/MAX8888 use a P-channel MOSFET pass transistor. Its dropout voltage is a function of drain-to-source on-resistance (R_{DS(ON)}) multiplied by the load current (see *Typical Operating Characteristics*).

$$V_{\text{DROPOUT}} = V_{\text{IN}} - V_{\text{OUT}} = R_{\text{DS(ON)}} \times I_{\text{OUT}}$$

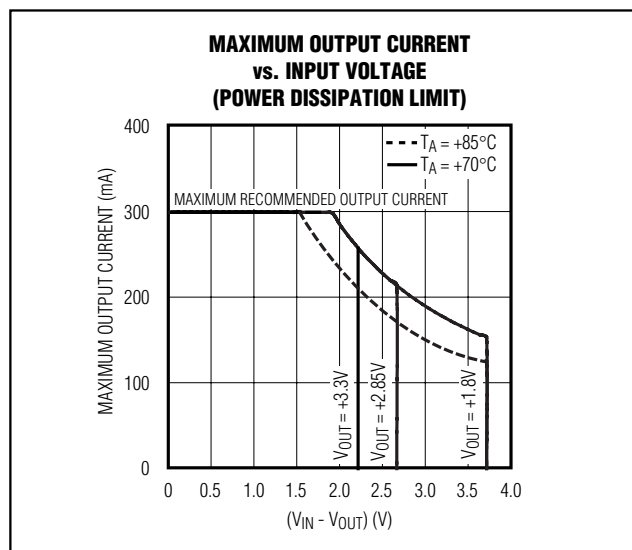


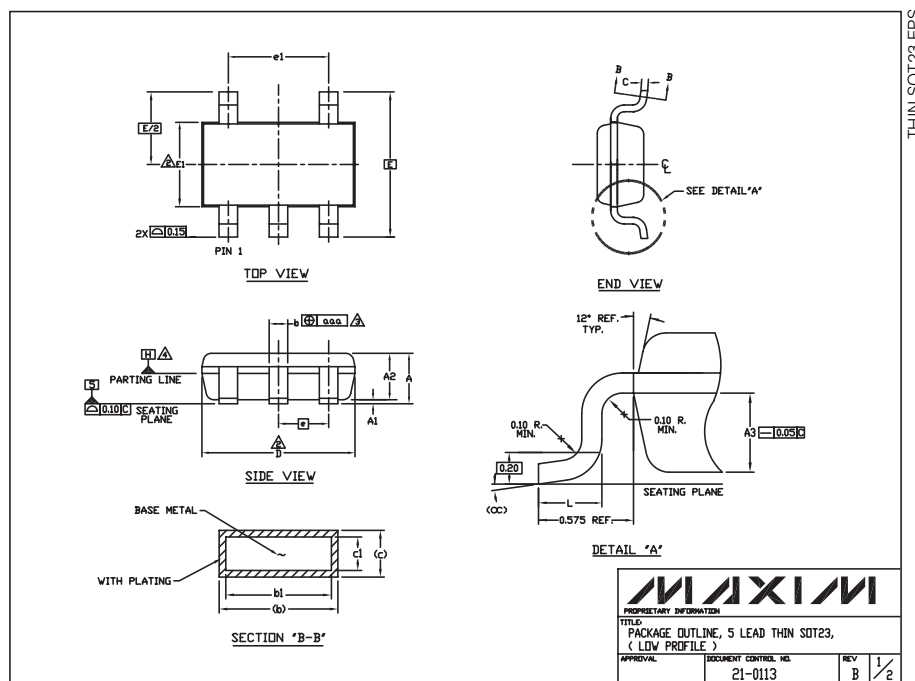
Figure 2. Power Operating Regions: Maximum Output Current vs. Input Voltage

Chip Information

TRANSISTOR COUNT: 620
PROCESS: BiCMOS

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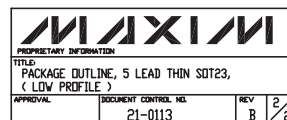
Package Information



NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. "D" AND "E1" ARE REFERENCE DATUM AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, AND ARE MEASURED AT THE BOTTOM PARTING LINE. MOLD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15mm ON "D" AND 0.25mm ON "E" PER SIDE.
3. THE LEAD WIDTH DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.07mm TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION.
4. DATUM PLANE "H" LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT THE BOTTOM OF PARTING LINE.
5. THE LEAD TIPS MUST LINE WITHIN A SPECIFIED TOLERANCE ZONE. THIS TOLERANCE ZONE IS DEFINED BY TWO PARALLEL LINES. ONE PLANE IS THE SEATING PLANE, DATUM [-C-]; AND THE OTHER PLANE IS AT THE SPECIFIED DISTANCE FROM [-C-] IN THE DIRECTION INDICATED. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITH 0.10mm AT SEATING PLANE.
6. THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-193 EXCEPT FOR THE "e" DIMENSION WHICH IS 0.95Mmm INSTEAD OF 1.00mm. THIS PART IS IN FULL COMPLIANCE TO EIAJ SPECIFICATION SC-74.

SYMBOLS			
	MIN	NOM	MAX
A	—	—	1.10
A1	0.05	0.075	0.10
A2	0.85	0.88	0.90
A3	0.50 BSC		
b	0.30	—	0.45
b1	0.25	0.35	0.40
c	0.15	—	0.20
c1	0.12	0.127	0.15
D	2.80	2.90	3.00
E	2.75 BSC		
E1	1.55	1.60	1.65
L	0.30	0.40	0.50
e1	1.90 BSC		
e	0.95 BSC		
OC	0°	4°	8°
aaa	0.20		



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